



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Trivedi et al.

Serial No.: 10/000,479

Filed: October 24, 2001

For: LOCAL INTERCONNECT STRUCTURE FOR INTEGRATED CIRCUIT DEVICES, SOURCE STRUCTURE FOR THE SAME, AND METHOD FOR FABRICATING THE SAME

Confirmation No.: 4131

Examiner: T. Nguyen

Group Art Unit: 2813

Attorney Docket No.: 2269-3439.4US

(97-0936.03/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 2021/1.

February 3, 2003 Date

> A. Walkowski Joseph

Name (Type/Print)

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Box Non-Fee Amendment Commissioner for Patents Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R.

Serial No. «Patent Application No»

§ 1.98(a). The listed documents were cited by the Office in co-pending application Serial No. 09/999,557, filed on October 19, 2001, and directed to a related invention.

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

U.S. Patent Documents

U.S. Patent No.	Publication Date	<u>Patentee</u>
US - 4,753,851	06/1988	Roberts et al.
US - 5,196,360	03/1993	Doan et al.

Foreign Patent Documents

Document No.	<u>Publication Date</u>	<u>Patentee</u>
JP 5-152449	06/1993	Tomoya Baba

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed after the mailing date of the first Office Action on the merits.

I hereby certify that no item of information contained in the Supplemental Information

Disclosure Statement was first cited in any communication from a foreign patent office in a

counterpart foreign application or, to the knowledge of the undersigned after making reasonable

Serial No. «Patent Application No»

inquiry, was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of the statement, and therefore no fee is due.

Respectfully submitted,

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Date: February 3, 2003

JAW/dlm:ljb

Enclosures: Form PTO-1449 or PTO/SB/08

Copy of documents cited

Document in ProLaw

PTO/SB/08A (10-01)

Approved for use through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Substitute for form 1449A/F A DEALER SUBSTITUTE FOR	Complete if Known			
INFORMATION DISCLOSURE	Application Number	10/000,479		
STATEMENT BY APPLICANT	Filing Date	October 24, 2001		
STATEMENT BY ATTLICANT	First Named Inventor	Trivedi et al.		
	Group Art Unit	2813		
(use as many sheets as necessary)	Examiner Name	T. Nguyen		
01	Attomay Docket Number	2269-3439 4115 (97-0936 03/115)		

		Document Number	Publication Date	Name of Patentee or Applicant of	Pages, Columns, Lines, Where Relevant
	Cite No.1	Number - Kind Code ² (if known)	MM-DD-YYYY	Cited Document	Passages or Relevant Figures Appear
		US-4,753,851	06/1988	Roberts et al.	
		US- 5,196,360	03/1993	Doan et al.	
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Examiner Cite Initials* No.1	Cite	Foreign Patent Document		Name of Patentee or	Pages, Columns, Lines,	
	Country Code ³ - Number ⁴ - Kind Code ⁵ (if known)	Publication Date MM-DD-YYYY	Applicant of Cited Document	Where Relevant Passages or Relevant Figures Appear	T ⁶	
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Examiner Signature		Date Considered	

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¹ Applicant's unique citation designation number (optional). ² See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.